# 2-Input NOR Gate

# **NL17SZ02**

The NL17SZ02 is a single 2-input NOR Gate in tiny footprint packages.

#### **Features**

- Designed for 1.65 V to 5.5 V V<sub>CC</sub> Operation
- 2.4 ns  $t_{PD}$  at  $V_{CC} = 5 \text{ V (typ)}$
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- I<sub>OFF</sub> Supports Partial Power Down Protection
- Source/Sink 24 mA at 3.0 V
- Available in SC-88A, SC-74A, SOT-553, SOT-953 and UDFN6 Packages
- Chip Complexity < 100 FETs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

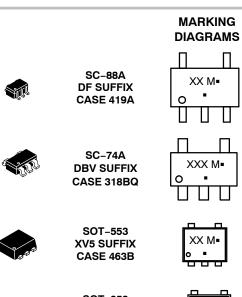


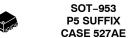
Figure 1. Logic Symbol



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UDFN6 1.0 x 1.0 CASE 517BX



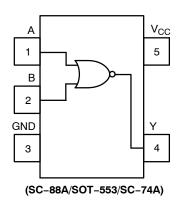
XX = Specific Device Code
M = Date Code\*
= Pb-Free Package

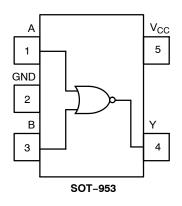
(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

## **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.





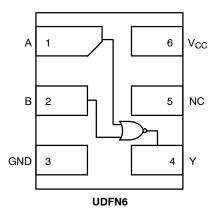


Figure 2. Pinout (Top View)

PIN ASSIGNMENT (SC-88A/SOT-553/SC-74A)

| Pin | Function        |
|-----|-----------------|
| 1   | A               |
| 2   | В               |
| 3   | GND             |
| 4   | Y               |
| 5   | V <sub>CC</sub> |

## PIN ASSIGNMENT (SOT-953)

| Pin | Function        |
|-----|-----------------|
| 1   | Α               |
| 2   | GND             |
| 3   | В               |
| 4   | Y               |
| 5   | V <sub>CC</sub> |

# PIN ASSIGNMENT (UDFN)

| Pin | Function        |
|-----|-----------------|
| 1   | Α               |
| 2   | В               |
| 3   | GND             |
| 4   | Υ               |
| 5   | NC              |
| 6   | V <sub>CC</sub> |

### **FUNCTION TABLE**

| Inp | Input |   |  |  |
|-----|-------|---|--|--|
| Α   | В     | Υ |  |  |
| L   | L     | Н |  |  |
| L   | Н     | L |  |  |
| Н   | L     | L |  |  |
| Н   | Н     | L |  |  |

### **MAXIMUM RATINGS**

| Symbol                              | Characteristics   |   | Value   | Unit |
|-------------------------------------|---|---|---|------|
| V <sub>CC</sub>                     | DC Supply Voltage SC-74A, SC-88A, SOT-953   | SC-88A (NLV)<br>3, SOT-553, UDFN6   | -0.5 to +7.0<br>-0.5 to +6.5                                  | V    |
| $V_{IN}$                            | DC Input Voltage SC-74A, SC-88A, SOT-953  | SC-88A (NLV)<br>B, SOT-553, UDFN6   | -0.5 to +7.0<br>-0.5 to +6.5                                  | V    |
| V <sub>OUT</sub>                    | SC-88A (NLV) Tri-   | e (High or Low State)<br>State Mode (Note 1)<br>vn Mode (V <sub>CC</sub> = 0 V) | -0.5 to V <sub>CC</sub> + 0.5<br>-0.5 to +7.0<br>-0.5 to +7.0 | V    |
|                                     | DC Output Voltage Active–Mode SC–74A, SC–88A, SOT–953, SOT–553, UDFN6 Tri–Power–Dov | -0.5 to V <sub>CC</sub> + 0.5<br>-0.5 to +6.5<br>-0.5 to +6.5                   | V   |      |
| I <sub>IK</sub>                     | DC Input Diode Current  | V <sub>IN</sub> < GND   | -50   | mA   |
| l <sub>ok</sub>                     | DC Output Diode Current   | V <sub>OUT</sub> < GND  | -50   | mA   |
| l <sub>out</sub>                    | DC Output Source/Sink Current   |   | ±50   | mA   |
| I <sub>CC</sub> or I <sub>GND</sub> | DC Supply Current per Supply Pin or Ground Pin                                      | ±100  | mA  |      |
| T <sub>STG</sub>                    | Storage Temperature Range   |   | -65 to +150   | °C   |
| T <sub>L</sub>                      | Lead Temperature, 1 mm from Case for 10 secs  |   | 260   | °C   |
| $T_J$                               | Junction Temperature Under Bias   |   | +150  | °C   |
| $	heta_{\sf JA}$                    | Thermal Resistance (Note 2)   | SC-88A<br>SC-74A<br>SOT-553<br>SOT-953<br>UDFN6                                 | 377<br>320<br>324<br>254<br>154                               | °C/W |
| P <sub>D</sub>                      | Power Dissipation in Still Air  | SC-88A<br>SC-74A<br>SOT-553<br>SOT-953<br>UDFN6                                 | 332<br>390<br>386<br>491<br>812                               | mW   |
| MSL                                 | Moisture Sensitivity  |   | Level 1   | _    |
| F <sub>R</sub>                      | Flammability Rating Ox  | ygen Index: 28 to 34  | UL 94 V-0 @ 0.125 in  | _    |
| V <sub>ESD</sub>                    | ESD Withstand Voltage (Note 3)  | Human Body Model<br>arged Device Model  | 2000<br>1000  | V    |
| I <sub>Latchup</sub>                | Latchup Performance (Note 4)  |   | ±100  | mA   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.

2. Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.

3. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.

4. Tested to EIA/JESD78 Class II.

#### RECOMMENDED OPERATING CONDITIONS

| Symbol                          | Characteristics  |   | Min         | Max                           | Unit |
|---------------------------------|--|---|-------------|-------------------------------|------|
| V <sub>CC</sub>                 | Positive DC Supply Voltage   |   | 1.65        | 5.5                           | V    |
| V <sub>IN</sub>                 | DC Input Voltage   |   | 0           | 5.5                           | V    |
| V <sub>OUT</sub>                |  | e-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>er-Down Mode (V <sub>CC</sub> = 0 V)   | 0<br>0<br>0 | V <sub>CC</sub><br>5.5<br>5.5 |      |
| T <sub>A</sub>                  | Operating Temperature Range  |   | -55         | +125                          | °C   |
| t <sub>r</sub> , t <sub>f</sub> | Input Rise and Fall Time<br>SC-88A (NLV)                           | V <sub>CC</sub> = 3.0 V to 3.6 V<br>V <sub>CC</sub> = 4.5 V to 5.5 V  | 0<br>0      | 100<br>20                     | ns/V |
|                                 | Input Rise and Fall Time (SC-74A, SC-88A, SOT-953, SOT-553, UDFN6) | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V} \\ V_{CC} = 2.3 \text{ V to } 2.7 \text{ V} \\ V_{CC} = 3.0 \text{ V to } 3.6 \text{ V} \\ V_{CC} = 4.5 \text{ V to } 5.5 \text{ V} \\ \end{cases}$ | 0<br>0<br>0 | 20<br>20<br>10<br>5           |      |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

### DC ELECTRICAL CHARACTERISTICS

|                  |                              |  | V <sub>CC</sub>  | T <sub>A</sub> = 25°C  |  |  | -55°C ≤ T  | <sub>A</sub> ≤ 125°C                             |       |
|------------------|------------------------------|--|--|--|--|--|--|--|-------|
| Symbol           | Parameter                    | Condition  | (V)  | Min  | Тур  | Max  | Min  | Max  | Units |
| V <sub>IH</sub>  | High-Level Input             |  | 1.65 to 1.95   | 0.65 V <sub>CC</sub>   | -  | _  | 0.65 V <sub>CC</sub>   | -  | V     |
|                  | Voltage                      |  | 2.3 to 5.5   | 0.70 V <sub>CC</sub>   | _  | -  | 0.70 V <sub>CC</sub>   | -  |       |
| $V_{IL}$         | Low-Level Input              |  | 1.65 to 1.95   | -  | _  | 0.35 V <sub>CC</sub>                             | -  | 0.35 V <sub>CC</sub>                             | V     |
|                  | Voltage                      |  | 2.3 to 5.5   | -  | -  | 0.30 V <sub>CC</sub>                             | -  | 0.30 V <sub>CC</sub>                             |       |
| V <sub>ОН</sub>  | High-Level Output<br>Voltage | $\begin{split} V_{IN} &= V_{IH} \text{ or } V_{IL} \\ I_{OH} &= -100  \mu\text{A} \\ I_{OH} &= -4 \text{ mA} \\ I_{OH} &= -8 \text{ mA} \\ I_{OH} &= -12 \text{ mA} \\ I_{OH} &= -16 \text{ mA} \\ I_{OH} &= -24 \text{ mA} \\ I_{OH} &= -32 \text{ mA} \end{split}$ | 1.65 to 5.5<br>1.65<br>2.3<br>2.7<br>3.0<br>3.0<br>4.5 | V <sub>CC</sub> - 0.1<br>1.29<br>1.9<br>2.2<br>2.4<br>2.3<br>3.8 | V <sub>CC</sub> 1.4 2.1 2.4 2.7 2.5 4.0          | -<br>-<br>-<br>-<br>-                            | V <sub>CC</sub> - 0.1<br>1.29<br>1.9<br>2.2<br>2.4<br>2.3<br>3.8 | -<br>-<br>-<br>-<br>-                            | V     |
| V <sub>OL</sub>  | Low-Level Output<br>Voltage  | $\begin{split} &V_{IN} = V_{IH} \text{ or } V_{IL} \\ &I_{OL} = 100  \mu\text{A} \\ &I_{OL} = 4 \text{ mA} \\ &I_{OL} = 8 \text{ mA} \\ &I_{OL} = 12 \text{ mA} \\ &I_{OL} = 16 \text{ mA} \\ &I_{OL} = 24 \text{ mA} \\ &I_{OL} = 32 \text{ mA} \end{split}$        | 1.65 to 5.5<br>1.65<br>2.3<br>2.7<br>3.0<br>3.0<br>4.5 | -<br>-<br>-<br>-   | -<br>0.08<br>0.2<br>0.22<br>0.28<br>0.38<br>0.42 | 0.1<br>0.24<br>0.3<br>0.4<br>0.4<br>0.55<br>0.55 | -<br>-<br>-<br>-   | 0.1<br>0.24<br>0.3<br>0.4<br>0.4<br>0.55<br>0.55 | V     |
| I <sub>IN</sub>  | Input Leakage Current        | V <sub>IN</sub> = 5.5 V or GND   | 1.65 to 5.5  | -  | _  | ±0.1   | -  | ±1.0   | μΑ    |
| I <sub>OFF</sub> | Power Off Leakage<br>Current | V <sub>IN</sub> = 5.5 V or<br>V <sub>OUT</sub> = 5.5 V   | 0  | -  | -  | 1.0  | -  | 10   | μΑ    |
| I <sub>CC</sub>  | Quiescent Supply<br>Current  | V <sub>IN</sub> = V <sub>CC</sub> or GND   | 5.5  | -  | -  | 1.0  | -  | 10   | μΑ    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

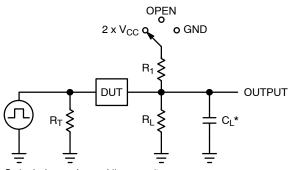
### **AC ELECTRICAL CHARACTERISTICS**

|                    |                                    |                                    | V <sub>CC</sub> |     | A = 25° | С   | -55°C ≤ T | <sub>A</sub> ≤ 125°C |       |
|--------------------|------------------------------------|------------------------------------|-----------------|-----|---------|-----|-----------|----------------------|-------|
| Symbol             | Parameter                          | Condition                          | (V)             | Min | Тур     | Max | Min       | Max                  | Units |
| t <sub>PLH</sub> , | Propagation Delay,                 | $R_L = 1 M\Omega$ , $C_L = 15 pF$  | 1.65 to 1.95    | -   | 5.3     | 11  | -         | 12                   | ns    |
| tPHL               | (A or B) to Y<br>(Figures 3 and 4) | $R_L = 1 M\Omega$ , $C_L = 15 pF$  | 2.3 to 2.7      | -   | 2.9     | 6.5 | -         | 7.0                  | 1     |
|                    |                                    | $R_L = 1 M\Omega$ , $C_L = 15 pF$  | 3.0 to 3.6      | -   | 2.3     | 4.5 | -         | 4.7                  | 1     |
|                    |                                    | $R_L = 500 \Omega$ , $C_L = 50 pF$ |                 | _   | 2.9     | 5.0 | -         | 5.2                  |       |
|                    |                                    | $R_L = 1 M\Omega$ , $C_L = 15 pF$  | 4.5 to 5.5      | _   | 1.9     | 3.9 | -         | 4.1                  |       |
|                    |                                    | $R_L = 500 \Omega$ , $C_L = 50 pF$ |                 | -   | 2.4     | 4.3 | -         | 4.5                  |       |

### **CAPACITIVE CHARACTERISTICS**

| Symbol           | Parameter                              | Condition   | Typical | Units |
|------------------|--|---|---------|-------|
| C <sub>IN</sub>  | Input Capacitance                      | $V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$  | 2.5     | pF    |
| C <sub>OUT</sub> | Output Capacitance                     | $V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$  | 2.5     | pF    |
| C <sub>PD</sub>  | Power Dissipation Capacitance (Note 5) | 10 MHz, $V_{CC}$ = 3.3 V, $V_{IN}$ = 0 V or $V_{CC}$ 10 MHz, $V_{CC}$ = 5.5 V, $V_{IN}$ = 0 V or $V_{CC}$ | 9<br>11 | pF    |

<sup>5.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no–load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.



| Test                                | Switch<br>Position  | C <sub>L</sub> , pF          | $R_L, \Omega$ | R <sub>1</sub> , Ω |  |
|-------------------------------------|---------------------|------------------------------|---------------|--------------------|--|
| t <sub>PLH</sub> / t <sub>PHL</sub> | Open                | See AC Characteristics Table |               |                    |  |
| t <sub>PLZ</sub> / t <sub>PZL</sub> | 2 x V <sub>CC</sub> | 50                           | 500           | 500                |  |
| t <sub>PHZ</sub> / t <sub>PZH</sub> | GND                 | 50                           | 500           | 500                |  |

X = Don't Care

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega)$ 

f = 1 MHz

Figure 3. Test Circuit

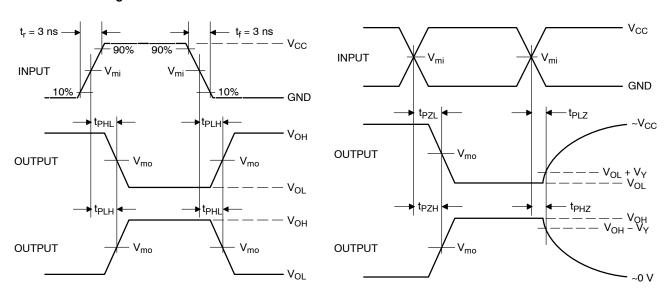


Figure 4. Switching Waveforms

|                     |                     | V <sub>m</sub>                      |   |                    |
|---------------------|---------------------|-------------------------------------|---|--------------------|
| V <sub>CC</sub> , V | V <sub>mi</sub> , V | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> , t <sub>PZH</sub> , t <sub>PHZ</sub> | V <sub>Y</sub> , V |
| 1.65 to 1.95        | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.15               |
| 2.3 to 2.7          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.15               |
| 3.0 to 3.6          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.3                |
| 4.5 to 5.5          | V <sub>CC</sub> /2  | V <sub>CC</sub> /2                  | V <sub>CC</sub> /2  | 0.3                |

### **DEVICE ORDERING INFORMATION**

| Device                             | Packages                | Specific Device Code  | Pin 1 Orientation<br>(See below) | Shipping <sup>†</sup> |
|------------------------------------|-------------------------|-----------------------|----------------------------------|-----------------------|
| NL17SZ02DFT2G                      | SC-88A                  | L3                    | Q4                               | 3000 / Tape & Reel    |
| NLV17SZ02DFT2G*                    | SC-88A                  | L3                    | Q4                               | 3000 / Tape & Reel    |
| NL17SZ02DBVT1G                     | SC-74A                  | AC                    | Q4                               | 3000 / Tape & Reel    |
| NL17SZ02XV5T2G                     | SOT-553                 | L3                    | Q4                               | 4000 / Tape & Reel    |
| NL17SZ02P5T5G                      | SOT-953                 | 4<br>(Rotated 90° CW) | Q2                               | 8000 / Tape & Reel    |
| NL17SZ02MU1TCG<br>(In Development) | UDFN6, 1.45 x 1.0, 0.5P | TBD                   | Q4                               | 3000 / Tape & Reel    |
| NL17SZ02MU3TCG<br>(In Development) | UDFN6, 1.0 x 1.0, 0.35P | J                     | Q4                               | 3000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# Pin 1 Orientation in Tape and Reel

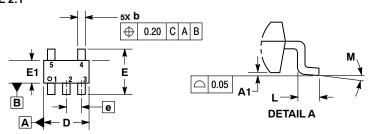
## **Direction of Feed**

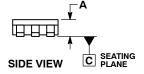


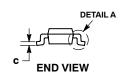
<sup>\*</sup>NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.



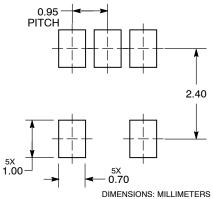
**DATE 18 JAN 2018** 







## **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
  Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.
  MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
  THICKNESS. MINIMUM LEAD THICKNESS IS THE
  MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

|     | MILLIMETERS |      |  |  |
|-----|-------------|------|--|--|
| DIM | MIN         | MAX  |  |  |
| Α   | 0.90        | 1.10 |  |  |
| A1  | 0.01        | 0.10 |  |  |
| b   | 0.25        | 0.50 |  |  |
| С   | 0.10        | 0.26 |  |  |
| D   | 2.85        | 3.15 |  |  |
| E   | 2.50        | 3.00 |  |  |
| E1  | 1.35        | 1.65 |  |  |
| е   | 0.95 BSC    |      |  |  |
| L   | 0.20        | 0.60 |  |  |
| М   | 0 °         | 10°  |  |  |

#### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

Μ = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

| DOCUMENT NUMBER: | 98AON66279G Electronic versions are uncontrolled except when accessed directly from the Document<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |  |             |
|------------------|---|--|-------------|
| DESCRIPTION:     | SC-74A  |  | PAGE 1 OF 1 |

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#### SC-88A (SC-70-5/SOT-353) CASE 419A-02 **ISSUE L**

**DATE 17 JAN 2013** 



- TES:
  DIMENSIONING AND TOLERANCING
  PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: INCH.
  419A-01 OBSOLETE. NEW STANDARD 3.
- 419A-02.
  DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

|     | INCHES    |       | MILLIN   | IETERS |
|-----|-----------|-------|----------|--------|
| DIM | MIN       | MAX   | MIN      | MAX    |
| Α   | 0.071     | 0.087 | 1.80     | 2.20   |
| В   | 0.045     | 0.053 | 1.15     | 1.35   |
| С   | 0.031     | 0.043 | 0.80     | 1.10   |
| D   | 0.004     | 0.012 | 0.10     | 0.30   |
| G   | 0.026     | BSC   | 0.65 BSC |        |
| Н   |           | 0.004 |          | 0.10   |
| J   | 0.004     | 0.010 | 0.10     | 0.25   |
| K   | 0.004     | 0.012 | 0.10     | 0.30   |
| N   | 0.008 REF |       | 0.20     | REF    |
| S   | 0.079     | 0.087 | 2.00     | 2.20   |

### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.



# 0.50 0.0197 0.65 0.025 0.65 0.025 0.40 0.0157 1.9 mm 0.0748 SCALE 20:1

**SOLDER FOOTPRINT** 

| STYLE 1:<br>PIN 1. BASE<br>2. EMITTER<br>3. BASE<br>4. COLLECTOR<br>5. COLLECTOR | STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE | STYLE 3:<br>PIN 1. ANODE 1<br>2. N/C<br>3. ANODE 2<br>4. CATHODE 2<br>5. CATHODE 1 | STYLE 4:<br>PIN 1. SOURCE 1<br>2. DRAIN 1/2<br>3. SOURCE 1<br>4. GATE 1<br>5. GATE 2 | STYLE 5: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4 |
|--|--|--|--|--|
|  |  |  |  |  |

| 5. COLLECTOR   | 5. CATHODE   | 5. CATHODE I   | 5. GATE 2  | 5. CATHODE 4  |
|--|--|--|--|---|
| STYLE 6:<br>PIN 1. EMITTER 2<br>2. BASE 2<br>3. EMITTER 1<br>4. COLLECTOR<br>5. COLLECTOR 2/BASE 1 | STYLE 7:<br>PIN 1. BASE<br>2. EMITTER<br>3. BASE<br>4. COLLECTOR<br>5. COLLECTOR | STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER | STYLE 9:<br>PIN 1. ANODE<br>2. CATHODE<br>3. ANODE<br>4. ANODE<br>5. ANODE | Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment. |

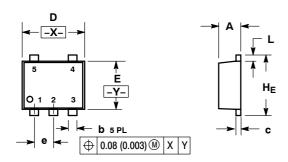
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| DESCRIPTION:     | SC-88A (SC-70-5/SOT-353) |   | PAGE 1 OF 1 |

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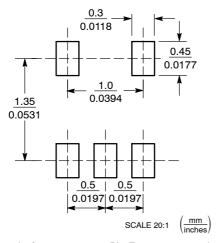


SOT-553, 5 LEAD CASE 463B ISSUE C

**DATE 20 MAR 2013** 



#### **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETERS

  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
  THICKNESS: MINIMUM LEAD THICKNESS IS THE MINIMUM
  THICKNESS OF BASE MATERIAL.

|     | MILLIMETERS |          |      | INCHES |           |       |
|-----|-------------|----------|------|--------|-----------|-------|
| DIM | MIN         | NOM      | MAX  | MIN    | NOM       | MAX   |
| Α   | 0.50        | 0.55     | 0.60 | 0.020  | 0.022     | 0.024 |
| b   | 0.17        | 0.22     | 0.27 | 0.007  | 0.009     | 0.011 |
| С   | 0.08        | 0.13     | 0.18 | 0.003  | 0.005     | 0.007 |
| D   | 1.55        | 1.60     | 1.65 | 0.061  | 0.063     | 0.065 |
| E   | 1.15        | 1.20     | 1.25 | 0.045  | 0.047     | 0.049 |
| е   |             | 0.50 BSC |      |        | 0.020 BSC |       |
| L   | 0.10        | 0.20     | 0.30 | 0.004  | 0.008     | 0.012 |
| He  | 1.55        | 1.60     | 1 65 | 0.061  | 0.063     | 0.065 |

#### **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

| STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR                     | STYLE 2: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4   | STYLE 3:<br>PIN 1. ANODE 1<br>2. N/C<br>3. ANODE 2<br>4. CATHODE 2<br>5. CATHODE 1 | STYLE 4:<br>PIN 1. SOURCE 1<br>2. DRAIN 1/2<br>3. SOURCE 1<br>4. GATE 1<br>5. GATE 2 | STYLE 5:<br>PIN 1. ANODE<br>2. EMITTER<br>3. BASE<br>4. COLLECTOR<br>5. CATHODE |
|---|--|--|--|---|
| STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 1 5. COLLECTOR 2/BASE 1 | STYLE 7:<br>PIN 1. BASE<br>2. EMITTER<br>3. BASE<br>4. COLLECTOR<br>5. COLLECTOR | STYLE 8:<br>PIN 1. CATHODE<br>2. COLLECTOR<br>3. N/C<br>4. BASE<br>5. EMITTER      | STYLE 9:<br>PIN 1. ANODE<br>2. CATHODE<br>3. ANODE<br>4. ANODE<br>5. ANODE           |   |

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PAGE 2 OF 2

| ISSUE | REVISION  | DATE        |
|-------|---|-------------|
| Α     | ADDED STYLES 3-9. REQ. BY D. BARLOW   | 11 NOV 2003 |
| В     | ADDED NOMINAL VALUES AND UPDATED GENERIC MARKING DIAGRAM. REQ. BY HONG XIAO | 27 MAY 2005 |
| С     | UPDATED DIMENSIONS D, E, AND HE. REQ. BY J. LETTERMAN.                      | 20 MAR 2013 |
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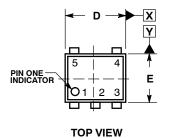
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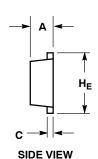


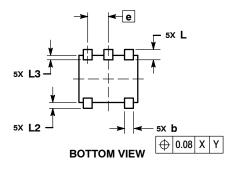
SOT-953 CASE 527AE **ISSUE E** 

**DATE 02 AUG 2011** 

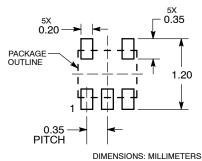








#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE
- MINIMUM THICKNESS OF THE BASE MATERIAL.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD
  FLASH, PROTRUSIONS, OR GATE BURRS.

|     | MILLIMETERS |                |      |  |  |
|-----|-------------|----------------|------|--|--|
| DIM | MIN         | NOM            | MAX  |  |  |
| Α   | 0.34        | 0.37           | 0.40 |  |  |
| b   | 0.10        | 0.10 0.15 0.20 |      |  |  |
| С   | 0.07        | 0.12           | 0.17 |  |  |
| D   | 0.95        | 1.00           | 1.05 |  |  |
| E   | 0.75        | 0.80           | 0.85 |  |  |
| е   |             | 0.35 BS        | С    |  |  |
| HE  | 0.95        | 1.00           | 1.05 |  |  |
| L   | 0.175 REF   |                |      |  |  |
| L2  | 0.05        | 0.10           | 0.15 |  |  |
| L3  |             |                | 0.15 |  |  |

#### **GENERIC MARKING DIAGRAM\***



= Specific Device Code = Month Code

\*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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| DESCRIPTION:     | SOT-953     |   | PAGE 1 OF 1 |

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